## Abstract Submitted for the MAR14 Meeting of The American Physical Society

Total Ionizing Dose (TID) Effects of  $\gamma$  Ray Radiation on  $Ag/AlO_x/Pt$  Resistive Switching Memory<sup>1</sup> FANG YUAN, ZHIGANG ZHANG, SHANSHAN SHEN, LIYANG PAN, JUN XU, Tsinghua University, MEMORY RESEARCH TEAM — The TID effects of  $\gamma$  rays generated from a  $^{60}$ Co source on the Ag/AlO<sub>x</sub>/Pt resistive switching (RS) memory is studied. Memory performances, including initial resistance state (IRS), low/high resistance state (LRS/HRS), forming voltage  $(V_f)$ , switching voltage  $(V_{set}/V_{reset})$  and retention reliability are examined on the memory devices before and after exposure to 1M rad (Si) radiation. The LRS is robust to the radiation whereas a little degeneration of uniformity is found in IRS and HRS, which is caused by the radiation induced defects (mainly holes), trapped in the oxide. For the same reason,  $V_{\rm f}$  increases several multiples after radiation. However surprisingly, both V<sub>set</sub> and V<sub>reset</sub> decrease during the RS and the retention performance is greatly improved. Based on these TID effects, it is proposed that the RS mechanism in  $Ag/AlO_x/Pt$ , Ag conducting filament based switching, may be reinforced through  $\gamma$  radiation, which assists in stabilizing the growth/rupture of Ag filaments. The high radiation tolerance of AlO<sub>x</sub>-based RS memory devices suggests a potential for aerospace and nuclear applications.

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